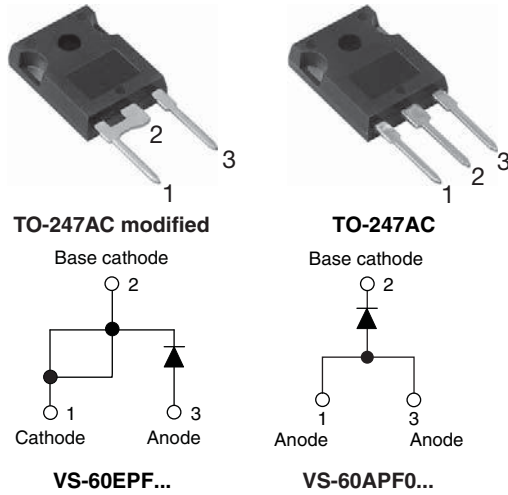


## Fast Soft Recovery Rectifier Diode, 60 A



### FEATURES

- Glass passivated pellet chip junction
- 150 °C max. operating junction temperature
- Low forward voltage drop and short reverse recovery time
- Designed and qualified according to JEDEC®-JESD 47
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**  
Available

### APPLICATIONS

These devices are intended for use in output rectification and freewheeling in inverters, choppers and converters as well as in input rectification where severe restrictions on conducted EMI should be met.

### DESCRIPTION

The VS-60EPF0... and VS-60APF0... soft recovery rectifier series has been optimized for combined short reverse recovery time and low forward voltage drop.

The glass passivation ensures stable reliable operation in the most severe temperature and power cycling conditions.

PRODUCT SUMMARY	
Package	TO-247AC modified (2 pins), TO-247AC
$I_{F(AV)}$	60 A
$V_R$	200 V, 400 V, 600 V
$V_F$ at $I_F$	1.3 V
$I_{FSM}$	830 A
$t_{rr}$	70 ns
$T_J$ max.	150 °C
Diode variation	Single die
Snap factor	0.5

MAJOR RATINGS AND CHARACTERISTICS			
SYMBOL	CHARACTERISTICS	VALUES	UNITS
$V_{RRM}$		200 to 600	V
$I_{F(AV)}$	Sinusoidal waveform	60	A
$I_{FSM}$		830	
$t_{rr}$	1 A, 100 A/ $\mu$ s	70	ns
$V_F$	30 A, $T_J = 25$ °C	1.1	V
$T_J$		-40 to +150	°C

VOLTAGE RATINGS			
PART NUMBER	$V_{RRM}$ , MAXIMUM PEAK REVERSE VOLTAGE V	$V_{RSM}$ , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	$I_{RRM}$ AT 150 °C mA
VS-60EPF02PbF, VS-60APF02PbF, VS-60EPF02-M3, VS-60APF02-M3	200	300	10
VS-60EPF04PbF, VS-60APF04PbF, VS-60EPF04-M3, VS-60APF04-M3	400	500	
VS-60EPF06PbF, VS-60APF06PbF, VS-60EPF06-M3, VS-60APF06-M3	600	700	



ABSOLUTE MAXIMUM RATINGS				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum average forward current	$I_{F(AV)}$	$T_C = 106\text{ }^\circ\text{C}$ , 180° conduction half sine wave	60	A
Maximum peak one cycle non-repetitive surge current	$I_{FSM}$	10 ms sine pulse, rated $V_{RRM}$ applied	700	
		10 ms sine pulse, no voltage reapplied	830	
Maximum $I^2t$ for fusing	$I^2t$	10 ms sine pulse, rated $V_{RRM}$ applied	2450	$A^2s$
		10 ms sine pulse, no voltage reapplied	3460	
Maximum $I^2\sqrt{t}$ for fusing	$I^2\sqrt{t}$	$t = 0.1\text{ ms to }10\text{ ms}$ , no voltage reapplied	34 600	$A^2\sqrt{s}$

ELECTRICAL SPECIFICATIONS				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum forward voltage drop	$V_{FM}$	60 A, $T_J = 25\text{ }^\circ\text{C}$	1.3	V
Forward slope resistance	$r_t$	$T_J = 150\text{ }^\circ\text{C}$	5.0	$m\Omega$
Threshold voltage	$V_{F(TO)}$		0.88	V
Maximum reverse leakage current	$I_{RM}$	$T_J = 25\text{ }^\circ\text{C}$	10	$mA$
		$T_J = 150\text{ }^\circ\text{C}$		

RECOVERY CHARACTERISTICS				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Reverse recovery time	$t_{rr}$	$I_F$ at 60 A <sub>pk</sub> 25 A/ $\mu$ s 25 °C	180	ns
Reverse recovery current	$I_{rr}$		3.4	A
Reverse recovery charge	$Q_{rr}$		0.5	$\mu$ C
Snap factor	S		Typical	0.5



THERMAL - MECHANICAL SPECIFICATIONS				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum junction and storage temperature range	$T_J, T_{Stg}$		-40 to +150	$^\circ\text{C}$
Maximum thermal resistance, junction to case	$R_{thJC}$	DC operation	0.4	$^\circ\text{C/W}$
Maximum thermal resistance, junction to ambient	$R_{thJA}$		40	
Typical thermal resistance, case to heatsink	$R_{thCS}$	Mounting surface, smooth and greased	0.2	
Approximate weight			6	g
			0.21	oz.
Mounting torque	minimum		6 (5)	$\text{kgf} \cdot \text{cm}$ $(\text{lbf} \cdot \text{in})$
	maximum		12 (10)	
Marking device	Case style TO-247AC modified		60EPF02	
			60EPF04	
			60EPF06	
	Case style TO-247AC		60APF02	
			60APF04	
			60APF06	



Fig. 1 - Current Rating Characteristics



Fig. 4 - Forward Power Loss Characteristics



Fig. 2 - Current Rating Characteristics



Fig. 5 - Maximum Non-Repetitive Surge Current



Fig. 3 - Forward Power Loss Characteristics

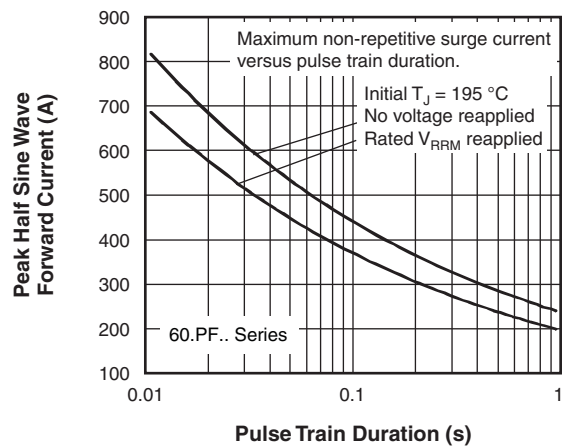


Fig. 6 - Maximum Non-Repetitive Surge Current

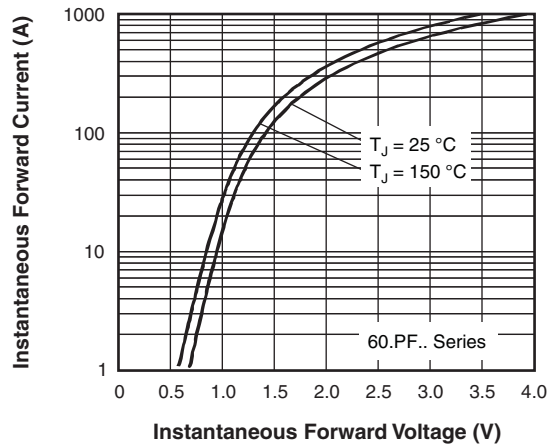


Fig. 7 - Forward Voltage Drop Characteristics

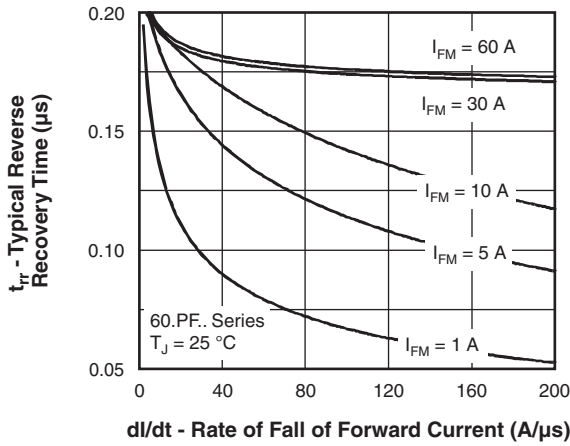


Fig. 8 - Recovery Time Characteristics,  $T_J = 25\text{ }^\circ\text{C}$

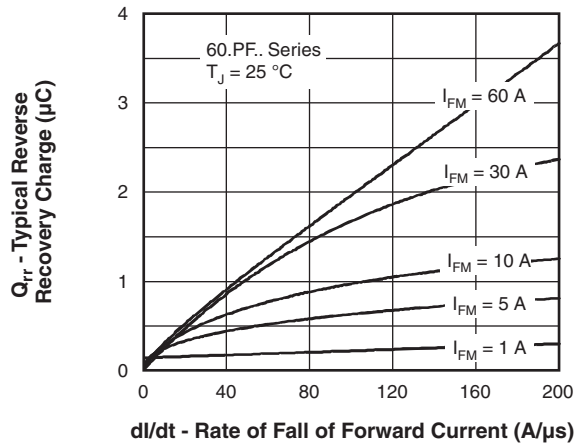


Fig. 10 - Recovery Charge Characteristics,  $T_J = 25\text{ }^\circ\text{C}$

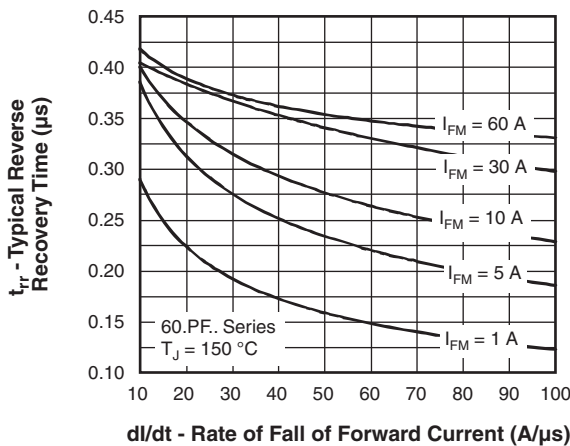


Fig. 9 - Recovery Time Characteristics,  $T_J = 150\text{ }^\circ\text{C}$



Fig. 11 - Recovery Charge Characteristics,  $T_J = 150\text{ }^\circ\text{C}$



Fig. 12 - Recovery Current Characteristics,  $T_J = 25\text{ }^\circ\text{C}$



Fig. 13 - Recovery Current Characteristics,  $T_J = 150\text{ }^\circ\text{C}$

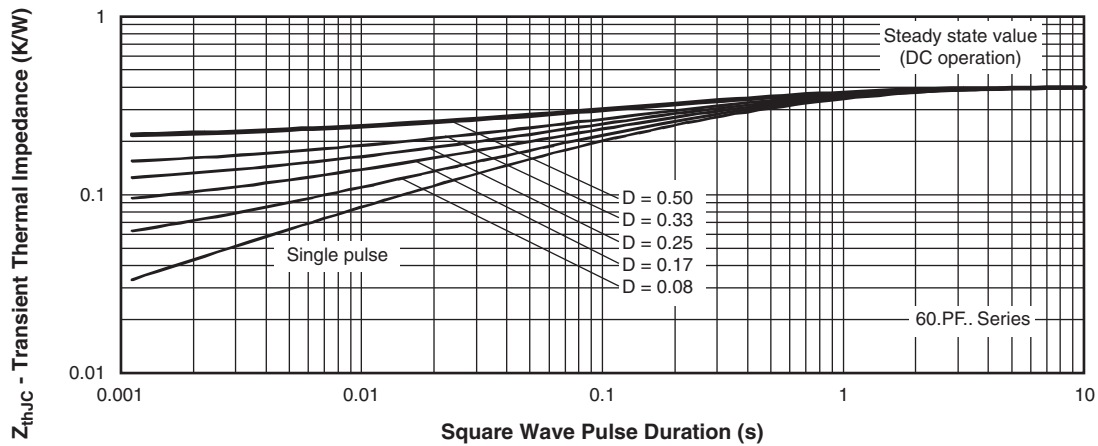
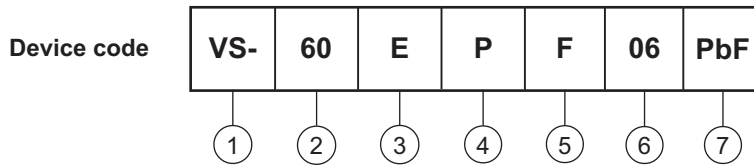


Fig. 14 - Thermal Impedance  $Z_{thJC}$  Characteristics



**ORDERING INFORMATION TABLE**



- 1** - Vishay Semiconductors product
- 2** - Current rating (60 = 60 A)
- 3** - Circuit configuration:  
E = single diode  
A = single diode, 3 pins
- 4** - Package:  
P = TO-247AC/TO-247AC modified
- 5** - Type of silicon:  
F = fast recovery
- 6** - Voltage code x 100 =  $V_{RRM}$ 

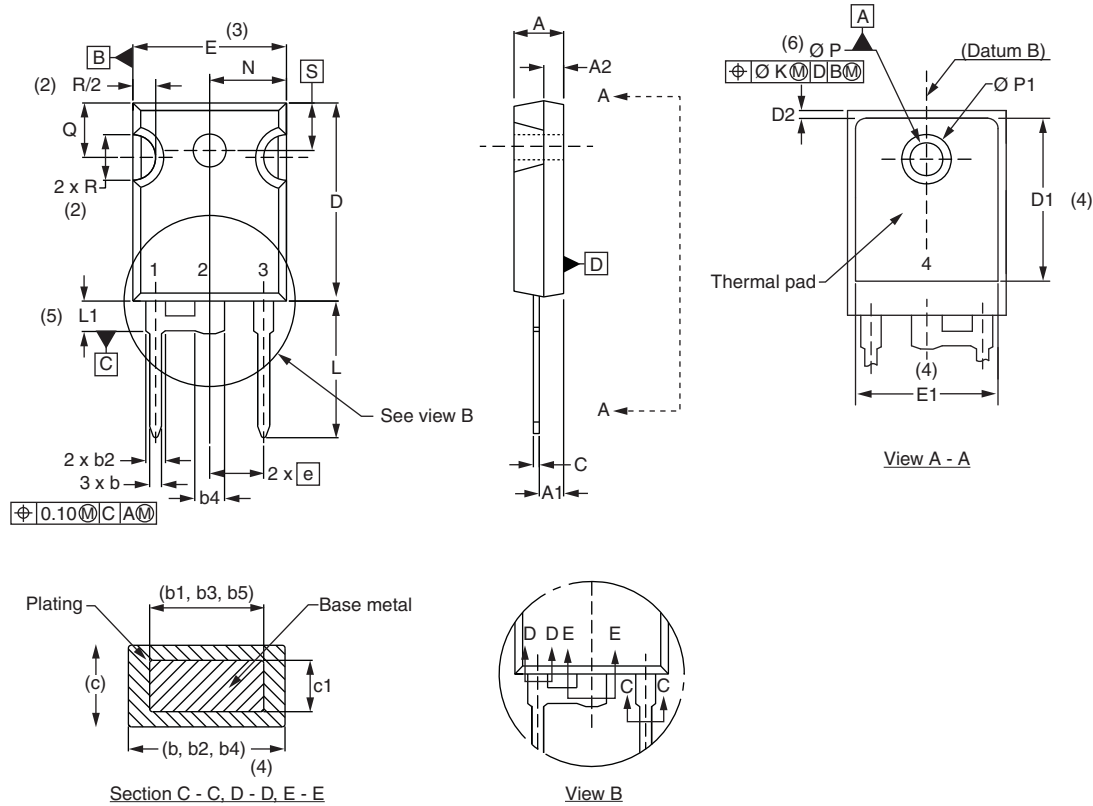
02 = 200 V
04 = 400 V
06 = 600 V
- 7** - Environmental digit:
  - PbF = lead (Pb)-free and RoHS-compliant
  - -M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free

<b>ORDERING INFORMATION (Example)</b>			
<b>PREFERRED P/N</b>	<b>QUANTITY PER T/R</b>	<b>MINIMUM ORDER QUANTITY</b>	<b>PACKAGING DESCRIPTION</b>
VS-60EPF02PbF	25	500	Antistatic plastic tubes
VS-60EPF02-M3	25	500	Antistatic plastic tubes
VS-60APF02PbF	25	500	Antistatic plastic tubes
VS-60APF02-M3	25	500	Antistatic plastic tubes
VS-60EPF04PbF	25	500	Antistatic plastic tubes
VS-60EPF04-M3	25	500	Antistatic plastic tubes
VS-60APF04PbF	25	500	Antistatic plastic tubes
VS-60APF04-M3	25	500	Antistatic plastic tubes
VS-60EPF06PbF	25	500	Antistatic plastic tubes
VS-60EPF06-M3	25	500	Antistatic plastic tubes
VS-60APF06PbF	25	500	Antistatic plastic tubes
VS-60APF06-M3	25	500	Antistatic plastic tubes

<b>LINKS TO RELATED DOCUMENTS</b>		
Dimensions	TO-247AC modified	<a href="http://www.vishay.com/doc?95541">www.vishay.com/doc?95541</a>
	TO-247AC	<a href="http://www.vishay.com/doc?95542">www.vishay.com/doc?95542</a>
Part marking information	TO-247AC modified PbF	<a href="http://www.vishay.com/doc?95255">www.vishay.com/doc?95255</a>
	TO-247AC modified -M3	<a href="http://www.vishay.com/doc?95442">www.vishay.com/doc?95442</a>
	TO-247AC PbF	<a href="http://www.vishay.com/doc?95226">www.vishay.com/doc?95226</a>
	TO-247AC -M3	<a href="http://www.vishay.com/doc?95007">www.vishay.com/doc?95007</a>
SPIICE model		<a href="http://www.vishay.com/doc?95275">www.vishay.com/doc?95275</a>

### TO-247 - 50 mils L/F modified

**DIMENSIONS** in millimeters and inches



SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	
A	4.65	5.31	0.183	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.17	1.37	0.046	0.054	
b	0.99	1.40	0.039	0.055	
b1	0.99	1.35	0.039	0.053	
b2	1.65	2.39	0.065	0.094	
b3	1.65	2.34	0.065	0.092	
b4	2.59	3.43	0.102	0.135	
b5	2.59	3.38	0.102	0.133	
c	0.38	0.89	0.015	0.035	
c1	0.38	0.84	0.015	0.033	
D	19.71	20.70	0.776	0.815	3
D1	13.08	-	0.515	-	4
D2	0.51	1.35	0.020	0.053	
E	15.29	15.87	0.602	0.625	3
E1	13.46	-	0.53	-	
e	5.46 BSC		0.215 BSC		
$\Phi K$	0.254		0.010		
L	14.20	16.10	0.559	0.634	
L1	3.71	4.29	0.146	0.169	
N	7.62 BSC		0.3		
$\Phi P$	3.56	3.66	0.14	0.144	
$\Phi P1$	-	7.39	-	0.291	
Q	5.31	5.69	0.209	0.224	
R	4.52	5.49	0.178	0.216	
S	5.51 BSC		0.217 BSC		

**Notes**

- (1) Dimensioning and tolerance per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1
- (6)  $\Phi P$  to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC® outline TO-247 with exception of dimension c and Q



TO-247 - 50 mils L/F

DIMENSIONS in millimeters and inches



SYMBOL	MILLIMETERS		INCHES		NOTES	SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.			MIN.	MAX.	MIN.	MAX.	
A	4.65	5.31	0.183	0.209		D2	0.51	1.35	0.020	0.053	
A1	2.21	2.59	0.087	0.102		E	15.29	15.87	0.602	0.625	3
A2	1.17	1.37	0.046	0.054		E1	13.46	-	0.53	-	
b	0.99	1.40	0.039	0.055		e	5.46 BSC		0.215 BSC		
b1	0.99	1.35	0.039	0.053		Ø K	0.254		0.010		
b2	1.65	2.39	0.065	0.094		L	14.20	16.10	0.559	0.634	
b3	1.65	2.34	0.065	0.092		L1	3.71	4.29	0.146	0.169	
b4	2.59	3.43	0.102	0.135		N	7.62 BSC		0.3		
b5	2.59	3.38	0.102	0.133		Ø P	3.56	3.66	0.14	0.144	
c	0.38	0.89	0.015	0.035		Ø P1	-	7.39	-	0.291	
c1	0.38	0.84	0.015	0.033		Q	5.31	5.69	0.209	0.224	
D	19.71	20.70	0.776	0.815	3	R	4.52	5.49	0.178	0.216	
D1	13.08	-	0.515	-	4	S	5.51 BSC		0.217 BSC		

Notes

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